



Patent Application No. 10/782,365
Customer Number: 42717

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Hsin-Ching Shih, et al.	§	Docket No.:	24061.473
		§		(TSMC2002-0181)
Serial No.:	10/782,365	§		
		§	Examiner:	Quang D. Vu
Filing Date:	February 19, 2004	§		
		§	Art Unit:	2811
For:	Seal Ring Design Without Stop	§		
	Layer Punch Through During via	§	Conf. No.:	4188
	Etch	§		

RESPONSE TO RESTRICTION REQUIREMENT

Mail Stop: Amendment
Commissioner for Patents
PO Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed October 14, 2004, applicant hereby elects, Group II, Claims 27-52, which is drawn to the structure of a seal ring over a semiconductor device.

Applicant's election is made with traverse on the grounds that the embodiments delineated by the examiner are not patentably distinct and therefore constitute a single invention concept.

An early action on the merits is respectfully requested.

Respectfully submitted,

David M. O'Dell
Reg. No. 42,044

Date: 11-29-04

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CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Mail Stop: Amendment, Commissioner For Patents, PO Box 1450, Alexandria, VA 22313-1450 on the date below.

Bonnie Boyle
Name

11-29-04
Date